

MSD103A~MSD103C

SCHOTTKY DIODES SCHOTTKY BARRIER SWITCHING DIODE

DESCRIPTION

The MSD103A~MSD103C are available in SOD-123 package.

ORDERING INFORMATION

Package Type	Part Number			
SOD-123	MSD103A			
	MSD103B			
	MSD103C			
Note 3,000pcs/ Ree				
AiT provides all RoHS Compliant Products				

PIN DESCRIPTION



FEATURES

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- Negligible Reverse Recovery Time
- Low Reverse Capacitance
- Also Available in Lead Free Version
- Available in SOD-123 package

MECHANICAL DATA

- Case: SOD-123, Plastic
- Case material UL Flammability Rating Classification 94V-0
- Moisture sensitivity: Level 1 per J-STD-020A
- Polarity: Cathode Band
- Leads: Solderable per MIL-STD-202, Method 208
- Also Available in Lead Free Plating (Matte Tin Finish).
- Weight: 0.01 grams (approx.)

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ABSOLUTE MAXIMUM RATINGS

@ T_A = 25°C, unless otherwise specified

Parameter	Symbol	MSD103A	MSD103B	MSD103C	Unit
Peak Repetitive Reverse Voltage	V_{RRM}				
Working Peak Reverse Voltage	V_{RWM}	40 30 20		20	V
DC Blocking Voltage	V_R				
RMS Reverse Voltage	$V_{R(RMS)}$	28	21	14	V
Forward Continuous Current ^{NOTE1}	I _{FM}	350			mA
Non-Repetitive Peak Forward Surge Current @ t ≤ 1.0s	IFSM	1.5			А
Power Dissipation ^{NOTE1}	P_D	400			mW
Thermal Resistance, Junction to Ambient AirNOTE1	R _θ JA	300			°C/W
Operating and Storage Temperature Range	T _J , T _{STG}		°C		

Stresses above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

NOTE1: Part mounted on FR-4 board with recommended pad layout, which can be found on our website

ELECTRICAL CHARACTERISTICS

@ T_A = 25°C, unless otherwise specified

Parameter	Symbol	Conditions		Min	Тур.	Max	Units
			MSD103A	40	-	-	
Reverse Breakdown	$V_{(BR)R}$	I _R = 100μA	MSD103B	30	-	-	V
Voltage ^{NOTE2}			MSD103C	20	-	-	1
Forward Voltage Drop ^{NOTE2}	V _{FM}	I _F = 20mA		-	-	0.37	V
		I _F = 200mA		-	-	0.60	
Peak Reverse CurrentNOTE2	I _{RM}	V _R = 30V	MSD103A	-	-		μА
		V _R = 20V	MSD103B	-	-	5.0	
		V _R = 10V	MSD103C	-	-		
Total Capacitance	Ст	V _R = 0V, f = 1.0MHz			28		pF
Reverse Recovery Time	t _{rr}	$I_F = I_R = 200 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$			10		ns

NOTE2: Short duration test pulse used to minimize self-heating effect.

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TYPICAL CHARACTERISTICS

Figure 1. Power Derating Curve

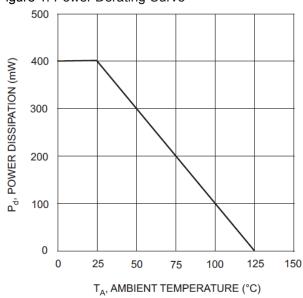


Figure 2. Typical Forward Characteristics

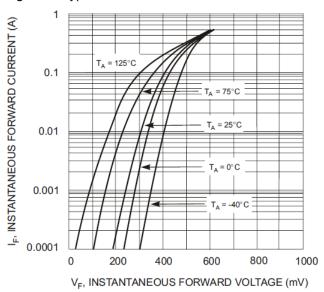


Figure 3. Typical Reverse Characteristics

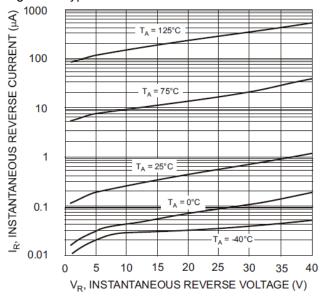
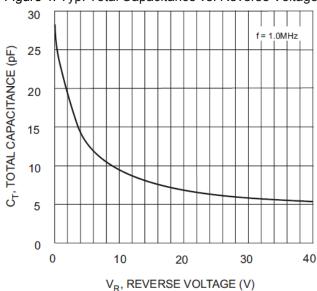


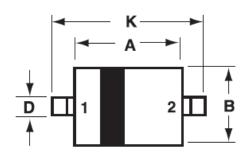
Figure 4. Typ. Total Capacitance vs. Reverse Voltage

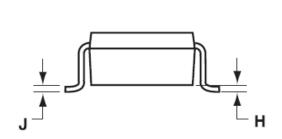


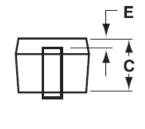
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PACKAGE INFORMATION

Dimension in SOD-123 Package (Unit: mm)







DIM	MILLIMETERS		INCHES		
	MIN	MAX	MIN	MAX	
Α	2.55	2.85	0.0995	0.1112	
В	1.40	1.80	0.0546	0.0702	
С	0.95	1.35	0.0371	0.0527	
D	0.50	0.70	0.0195	0.0273	
Е	0.30	REF	0.01	17REF	
Н	-	0.10	-	0.0039	
J	-	0.15	-	0.0056	
K	3.55	3.85	0.1385	0.1502	

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